

MFE211-MFE212

DUAL GATE MOSFETS

FEATURES

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain Source Voltage	V_{DSX}	20	Vdc
Drain Gate Voltage	V_{DG1} V_{DG2}	35 35	Vdc
Gate Current	I_{G1} I_{G2}	± 10 ± 10	mAdc
Drain Current – Continuous	I_D	50	mAdc
Total Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	360 2.4	mW mW/ $^\circ\text{C}$
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	1.2 8.0	Watt mW/ $^\circ\text{C}$
Storage Channel Temperature Range	T_{stg}	-65 to +200	$^\circ\text{C}$
Junction Temperature Range	T_J	-65 to +175	$^\circ\text{C}$
Lead Temperature, 1/16" from Seated Surface for 10 Seconds	T_L	300	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristics		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Drain Source Breakdown Voltage ($I_D = 10 \mu\text{Adc}$, $V_{G1S} = V_{G2S} = -4.0 \text{ Vdc}$)		$V_{(BR)DSX}$	20	-	Vdc
Gate 1 – Source Breakdown Voltage⁽¹⁾ ($I_{G1} = \pm 10 \text{ mAdc}$, $V_{G2S} = V_{DS} = 0$)		$V_{(BR)G1S0}$	± 6.0	-	Vdc
Gate 2 – Source Breakdown Voltage⁽¹⁾ ($I_{G2} = \pm 10 \text{ mAdc}$, $V_{G1S} = V_{DS} = 0$)		$V_{(BR)G2S0}$	± 6.0	-	Vdc
Gate 1 to Source Cutoff Voltage ($V_{DS} = 15 \text{ Vdc}$, $V_{G2S} = 4.0 \text{ Vdc}$, $I_D = 20 \mu\text{Adc}$)	MFE211	$V_{G1S(off)}$	-0.5	-5.5	Vdc
	MFE212		-0.5	-4.0	
Gate 2 to Source Cutoff Voltage ($V_{DS} = 15 \text{ Vdc}$, $V_{G1S} = 0$, $I_D = 20 \mu\text{Adc}$)	MFE211	$V_{G2S(off)}$	-0.2	-2.5	Vdc
	MFE212		-0.2	-4.0	
Gate 1 Leakage Current ($V_{G1S} = \pm 5.0 \text{ Vdc}$, $V_{G2S} = V_{DS} = 0$) ($V_{G1S} = -5.0 \text{ Vdc}$, $V_{G2S} = V_{DS} = 0$, $T_A = 150^\circ\text{C}$)		I_{G1SS}	- -	± 10 -10	mAdc μAdc
Gate 2 Leakage Current ($V_{G2S} = \pm 5.0 \text{ Vdc}$, $V_{G1S} = V_{DS} = 0$) ($V_{G2S} = -5.0 \text{ Vdc}$, $V_{G1S} = V_{DS} = 0$, $T_A = 150^\circ\text{C}$)		I_{G2SS}	- -	± 10 -10	nAdc μAdc
ON CHARACTERISTICS					
Zero-Gate Voltage Drain Current⁽²⁾ ($V_{DS} = 15 \text{ Vdc}$, $V_{G1S} = 0$, $V_{G2S} = 4.0 \text{ Vdc}$)		I_{DSS}	6.0	40	mAdc
SMALL SIGNAL CHARACTERISTICS					
Forward Transfer Admittance⁽³⁾ ($V_{DS} = 15 \text{ Vdc}$, $V_{G2S} = 4.0 \text{ Vdc}$, $V_{G1S} = 0$, $f = 1.0 \text{ kHz}$)		$ Y_{fs} $	17	40	mmhos
Reverse Transfer Capacitance ($V_{DS} = 15 \text{ Vdc}$, $V_{G2S} = 4.0 \text{ Vdc}$, $I_D = 10 \text{ mAdc}$, $f = 1.0 \text{ MHz}$)		C_{rss}	0.005	0.05	pF

MFE211-MFE212

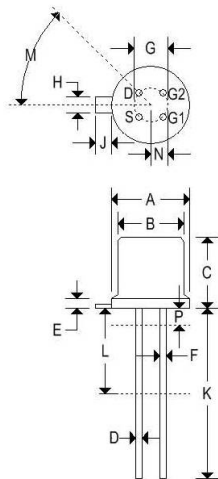
DUAL GATE MOSFETS

FUNCTIONAL CHARACTERISTICS					
Noise Figure ($V_{DD} = 18 \text{ Vdc}$, $V_{GG} = 7.0 \text{ Vdc}$, $f = 200 \text{ MHz}$) ($V_{DD} = 24 \text{ Vdc}$, $V_{GG} = 6.0 \text{ Vdc}$, $f = 45 \text{ MHz}$)	MFE211 MFE212	NF	- -	3.5 4.0	dB
Common Source Power Gain ($V_{DD} = 18 \text{ Vdc}$, $V_{GG} = 7.0 \text{ Vdc}$, $f = 200 \text{ MHz}$) ($V_{DD} = 18 \text{ Vdc}$, $V_{GG} = 6.0 \text{ Vdc}$, $f = 45 \text{ MHz}$) ($V_{DD} = 18 \text{ Vdc}$, $f_{LO} = 245 \text{ MHz}$, $f_{RF} = 200 \text{ MHz}$)	MFE211 MFE211 MFE212	G_{ps} $G_c^{(5)}$	24 29 21	35 37 28	dB
Bandwidth ($V_{DD} = 18 \text{ Vdc}$, $V_{GG} = 7.0 \text{ Vdc}$, $f = 200 \text{ MHz}$) ($V_{DD} = 18 \text{ Vdc}$, $f_{LO} = 245 \text{ MHz}$, $f_{RF} = 200 \text{ MHz}$) ($V_{DD} = 18 \text{ Vdc}$, $V_{GG} = 6.0 \text{ Vdc}$, $f = 45 \text{ MHz}$)	MFE211 MFE212 MFE211	BW	5.0 4.0 3.5	12 7.0 6.0	MHz
Gain Control Gate Supply Voltage ⁽⁴⁾ ($V_{DD} = 18 \text{ Vdc}$, $\Delta G_{ps} = -30 \text{ dB}$, $f = 200 \text{ MHz}$) ($V_{DD} = 18 \text{ Vdc}$, $\Delta G_{ps} = -30 \text{ dB}$, $f = 45 \text{ MHz}$)	MFE211 MFE211	$V_{GG(GC)}$	- -	-2.0 ± 1.0	Vdc

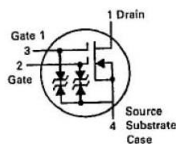
1. All gate breakdown voltages are measured while the device is conducting rated gate current. This ensures that the gate voltage limiting network is functioning properly.
2. Pulse test: Pulse width = 300 μ s, duty cycle $\leq 2\%$.
3. This parameter must be measured with bias voltages applied for less than 5 seconds to avoid overheating. The signal is applied to gate 1 with gate 2 at ac ground.
4. ΔG_{ps} is defined as the change in G_{ps} from the value at $V_{GG} = 7.0 \text{ volts}$ (MFE211).
5. Power Gain Conversion. Amplitude at input from local oscillator is adjusted for maximum G_c .

MECHANICAL CHARACTERISTICS

Case:	TO-72
Marking:	Alpha-numeric
Pin out:	See below



	TO-72			
	Inches		Millimeters	
	Min	Max	Min	Max
A	-	0.230	-	5.840
B	-	0.195	-	4.950
C	-	0.210	-	5.330
D	-	0.021	-	0.530
E	-	0.030	-	0.760
F	-	0.019	-	0.480
G	0.100 BSC		2.540 BSC	
H	-	0.046	-	1.170
J	-	0.048	-	1.220
K	0.500	-	12.700	-
L	0.250	-	-	6.350
M	45° BSC		45° BSC	
N	0.050 BDC		1.270 BSC	
P	-	0.050	-	1.270



MFE211-MFE212

DUAL GATE MOSFETS

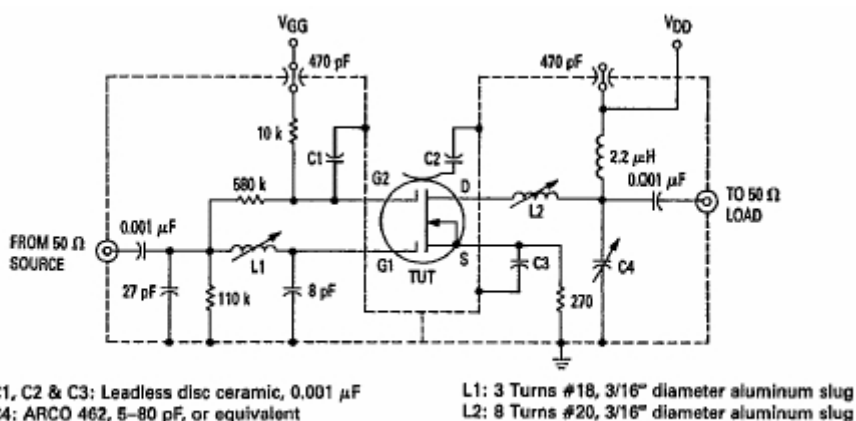


Figure 1. 200 MHz Power Gain, Gain Control Voltage, and Noise Figure Test Circuit for MFE211

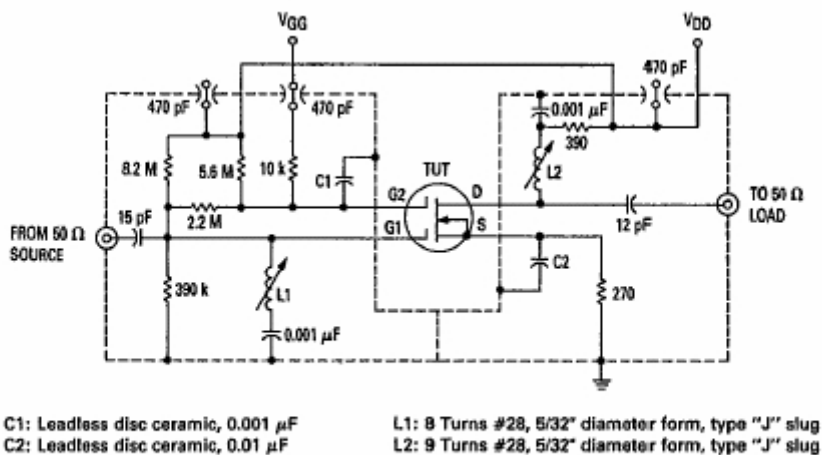


Figure 2. 45 MHz Power Gain and Noise Figure Test Circuit for MFE211

MFE211-MFE212

DUAL GATE MOSFETS

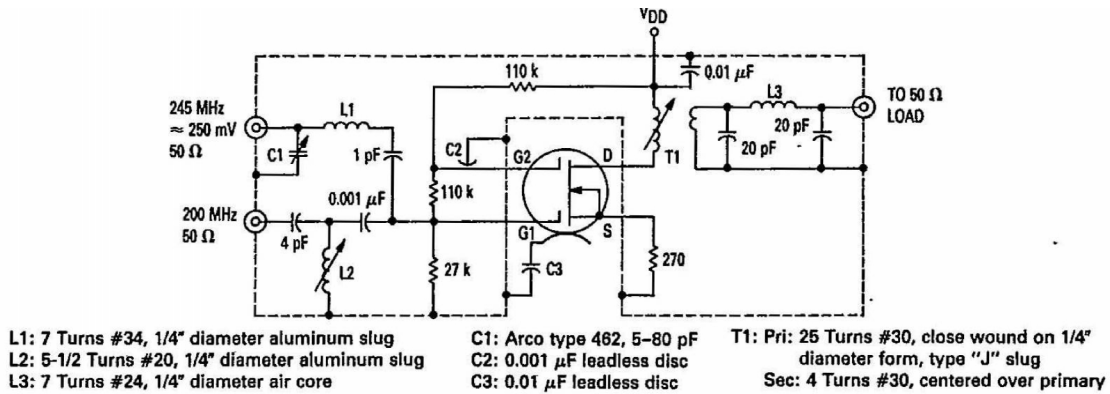


Figure 3. 200 MHz-to-45 MHz Circuit for Conversion Power Gain for MFE212

TYPICAL CHARACTERISTICS

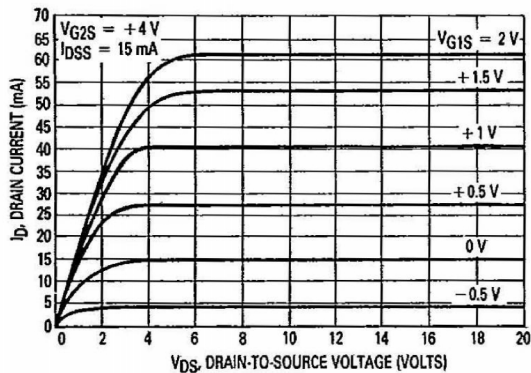


Figure 4. Drain Current versus Drain-to-Source Voltage

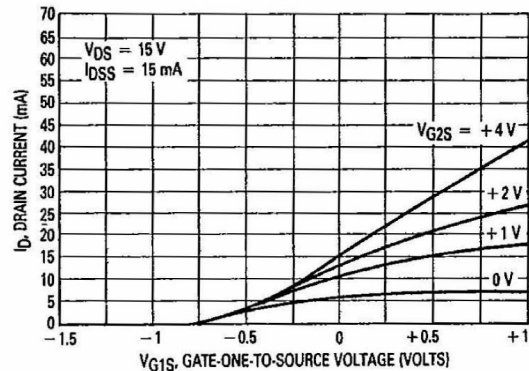


Figure 5. Drain Current versus Gate-One-to-Source Voltage

SMALL-SIGNAL COMMON-SOURCE PARAMETER

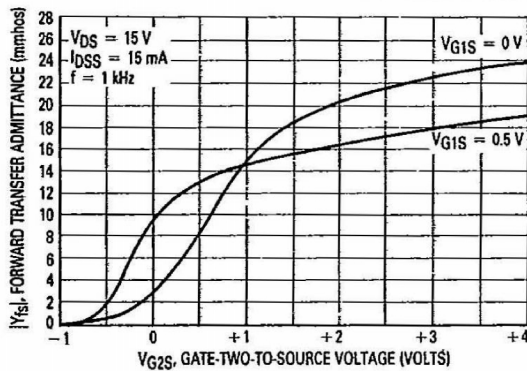


Figure 6. Forward Transfer Admittance versus Gate-Two-to-Source Voltage

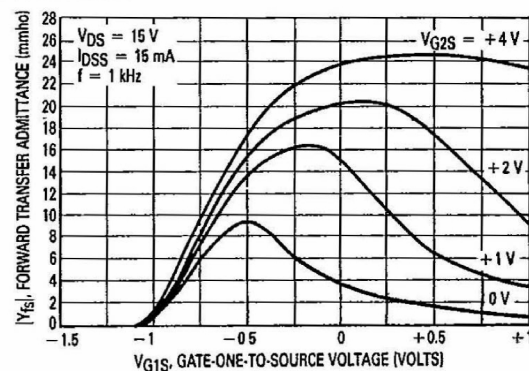


Figure 7. Forward Transfer Admittance versus Gate-One-to-Source Voltage

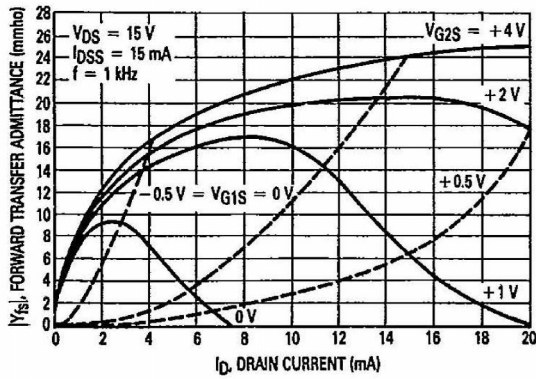


Figure 8. Forward Transfer Admittance versus Drain Current

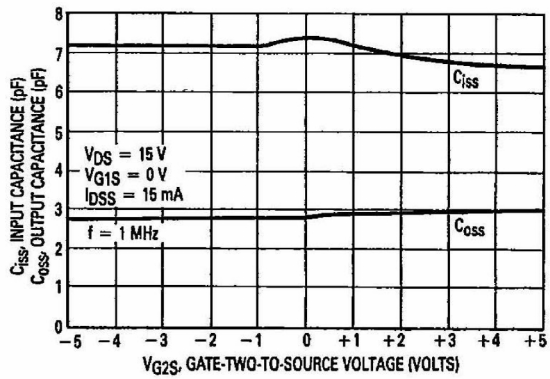


Figure 9. Input and Output Capacitance versus Gate-Two-to-Source Voltage

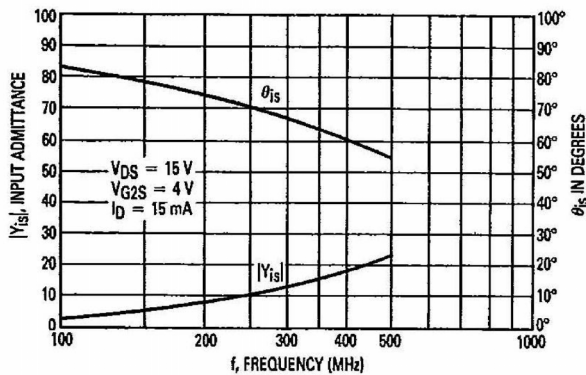


Figure 10. Small-Signal Gate-One Input Admittance versus Frequency

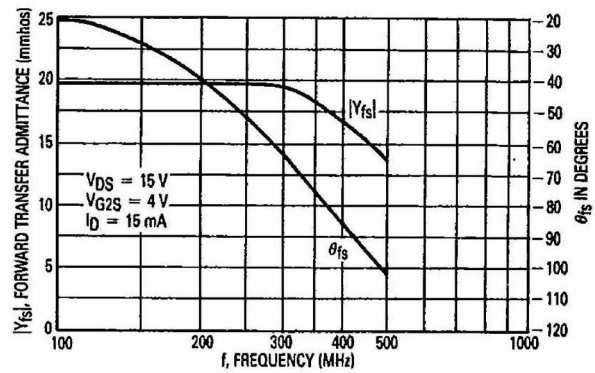


Figure 11. Small-Signal Forward Transfer Admittance versus Frequency

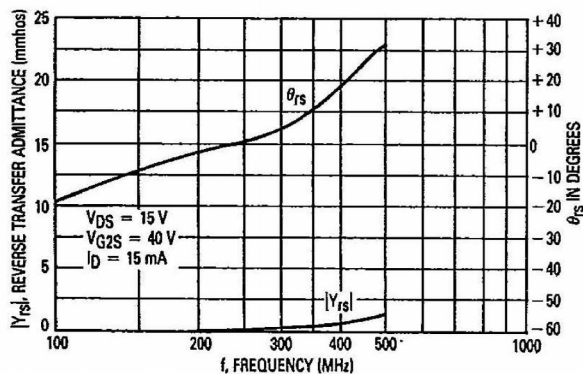


Figure 12. Small-Signal Gate-One Reverse Transfer Admittance versus Frequency

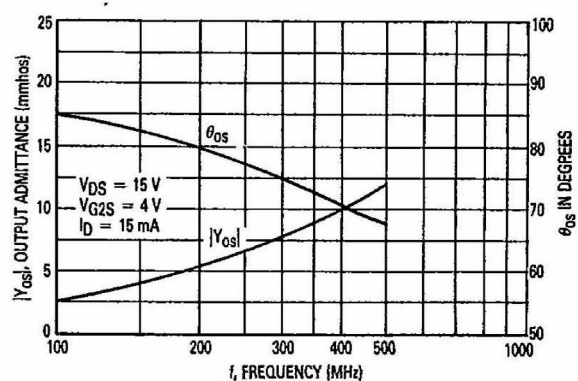
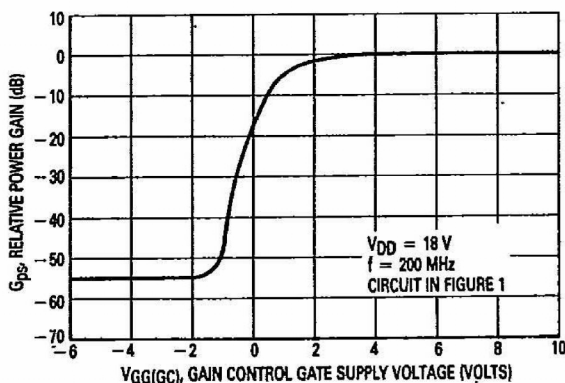


Figure 13. Small-Signal Gate-One Output Admittance versus Frequency

MFE211-MFE212

DUAL GATE MOSFETS



**Figure 14. Relative Small-Signal Power Gain versus Gain Control Gate Supply Voltage
MFE211**

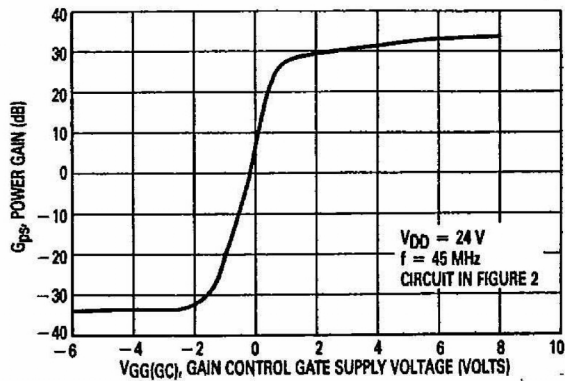


Figure 15. Small-Signal Common-Source Insertion Power Gain versus Gain Control Gate Supply Voltage

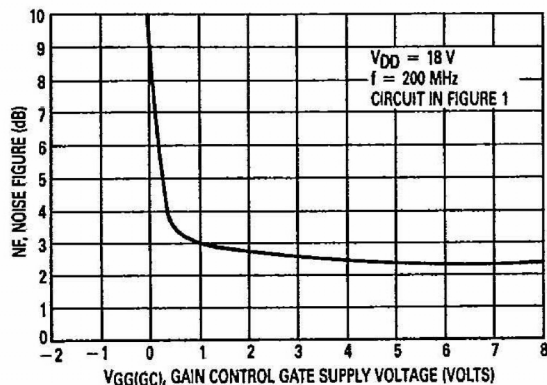


Figure 16. Common Source Spot Noise Figure versus Gain Control Gate Supply Voltage

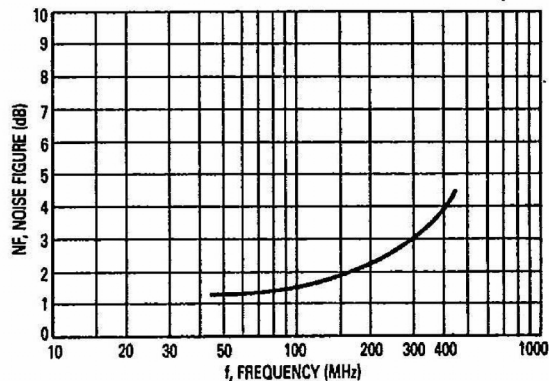


Figure 17. Optimum Spot Noise Figure versus Frequency